



LOW POWER QUAD OPERATIONAL AMPLIFIERS

Description

The AS324/324A consist of four independent, high gain and internally frequency compensated operational amplifiers. They are specifically designed to operate from a single power supply. Operation from split power supplies is also possible and the low power supply current drain is independent of the magnitude of the power supply voltage. Typical applications include transducer amplifiers, DC gain blocks and most conventional operational amplifier circuits.

The AS324/324A series are compatible with industry standard 324. The AS324A has more stringent input offset voltage than AS324.

The AS324 is available in SOIC-14, DIP-14 and TSSOP-14 packages, and the AS324A is available in SOIC-14 package.

Features

- Internally Frequency Compensated for Unity Gain
- Large Voltage Gain: 100dB (Typical)
- Low Input Bias Current: 20nA (Typical)
- Low Input Offset Voltage: 2mV (Typical)
- Low Supply Current: 0.5mA (Typical)
- Wide Power Supply Voltage Range:
 - Single Supply: 3V to 36V
 - Dual Supplies: ±1.5V to ±18V
- Input Common Mode Voltage Range Includes Ground
- Large Output Voltage Swing: 0V to V_{CC} -1.5V
- Power Drain Suitable for Battery Operation

Applications

- Battery Charger
- Cordless Telephone
- Switching Power Supply

Pin Assignments

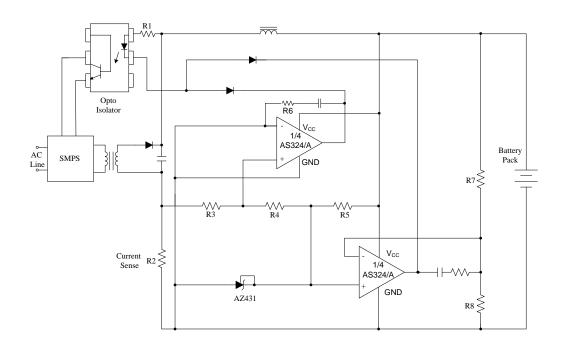
(Top View) (Top View) **OUTPUT 1** 14 **OUTPUT 4 OUTPUT 1 OUTPUT 4** 14 INPUT 1-13 INPUT 4-INPUT 1-13 INPUT 4-INPUT 1+ 12 INPUT 4+ INPUT 1+ INPUT 4+ 12 4 V_{CC} 11 **GND** 11 GND V_{CC} INPUT 2+ 10 INPUT 3+ INPUT 3+ INPUT 2+ 10 INPUT 2-6 9 INPUT 3-INPUT 2-9 INPUT 3-OUTPUT 2 8 **OUTPUT 3** 8 **OUTPUT 3** OUTPUT 2

(SOIC-14/TSSOP-14 / M/G Package)

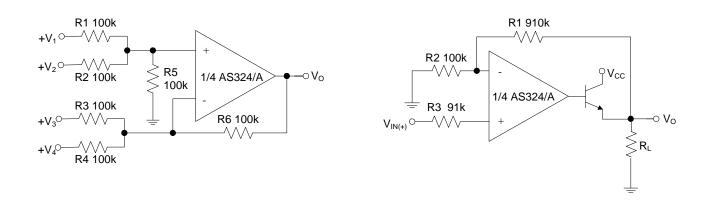
(DIP-14/ P Package)



Typical Applications Circuit



Battery Charger

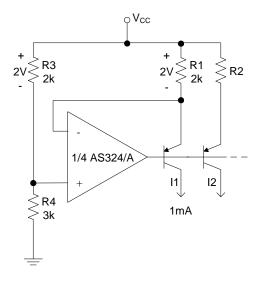


DC Summing Amplifier

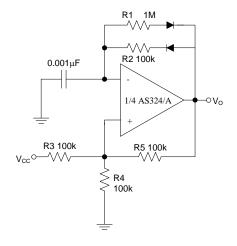
Power Amplifier



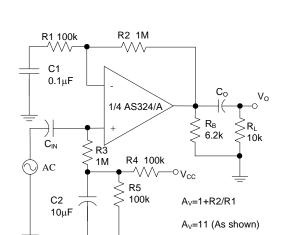
Typical Applications Circuit (Cont.)



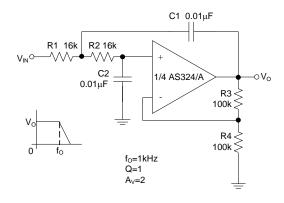
Fixed Current Sources



Pulse Generator



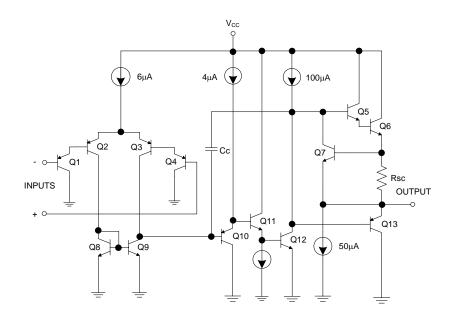
AC Coupled Non-Inverting Amplifier



DC Coupled Low-Pass RC Active Filter



Functional Block Diagram



Absolute Maximum Ratings (Note 1)

Symbol	Parameter	Rati	Unit		
Vcc	Supply Voltage	40		V	
V _{ID}	Differential Input Voltage	40		V	
V _{IN}	Input Voltage	-0.3 to 40		V	
P _D		DIP-14	1130		
	Total Power Dissipation (T _A = +25°C)	SOIC-14	800	mW	
		TSSOP-14	710		
TJ	Operating Junction Temperature	+150		°C	
T _{STG}	Storage Temperature Range	-65 to +150		°C	
T _{LEAD}	Lead Temperature (Soldering, 10 Seconds)	+260		°C	

Note 1: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
Vcc	Supply Voltage	3	36	V
T _A	Ambient Operating Temperature Range	-40	+85	°C





AS324/324A

Electrical Characteristics (Limits in standard typeface are for $T_A = +25^{\circ}\text{C}$, **bold** typeface applies over $T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ (Note 2), $V_{CC} = 5V$, GND = 0V, unless otherwise specified.)

Symbol	Para	ameter	Conditi	Min	Тур	Max	Unit	
V _{IO} Input Offset Voltage			A C 2 2 4	_	2	5	mV	
	land of Office () / ellipses			AS324	-	-		7
	input Offset Voltage		$V_O = 1.4V$, $R_S = 0\Omega$, $V_{CC} = 5V$ to $30V$	A C 2 2 4 A	-	2	3	mV
				AS324 A	-	-	5	
ΔV _{IO} /ΔΤ	Average Temperature Offset Voltage	Coefficient of Input	$T_A = -40 \text{ to } +85^{\circ}\text{C}$		-	7	-	μV/°C
l	Input Offset Current		L. L. V. OV		-	5	30	^
I _{IO}	Input Offset Current		I _{IN} + - I _{IN} -, V _{CM} = 0V		-	-	100	nA
	Innut Ding Current				-	20	100	π Λ
I _{BIAS}	Input Bias Current		I_{IN} + or I_{IN} -, V_{CM} = 0V		-	-	200	nA
V_{IR}	Input Common Mode	Voltage Range (Note 3)	V _{CC} = 30V		0	_	V _{CC} - 1.5	V
	0	oly Current	$T_A = -40 \text{ to } +85^{\circ}\text{C},$	V _{CC} = 30V	-	1.0	3	mA
Icc	Supply Current		R _L = ∞	V _{CC} = 5V	-	0.7	1.2	
0	Large Circal Valtage	e Gain	$V_{CC} = 15V$, $R_L \ge 2k\Omega$, $V_O = 1V$ to 11V		85	100	-	- dB
G∨	Large Signal Voltage (80	-	_	
OMPR	Occasion Maria Delega	Police Police	4.5))/	60	70	-	dB	
CMRR Common Mode Reject	in Ratio DC , $V_{CM} = 0$ to	DC, $V_{CM} = 0$ to (V_{CC})	1.5)V	60	-	_		
DODD	PSRR Power Supply Rejection Ratio		V _{CC} = 5 to 30V		70	100	-	
PSKK					60	-	_	dB
CS	Channel Separation		f = 1kHz to 20kHz		-	-120	-	dB
		Source	V _{IN} + = 1V, V _{IN} - = 0V, V _{CC} = 15V, V _O = 2V		20	40		mA
I _{SOURCE}					20	_	-	
	Output Current	st Sink	V _{IN} += 0V, V _{IN} -= 1V, V _{CC} = 15V, V _O = 2V V _{IN} += 0V, V _{IN} -= 1V, V _{CC} = 15V, V _O = 0.2V		10	15	-	mA
I _{SINK}					5	_	_	
					12	50	_	μΑ
Isc	Output Short Circuit Current to Ground		V _{CC} = 15V		_	40	60	mA
Vон			V 00V D 015		26	_	_	
				$V_{CC} = 30V, R_L = 2k\Omega$		-	-	V
		$V_{CC} = 30V$, $R_L = 10k\Omega$		27	28	_		
	Output Voltage Swing			27	_	_		
			V 5V D 40L2		-	5	20	//
V_{OL}			$V_{CC} = 5V$, $R_L = 10k\Omega$		-	-	30	mV
0	The man all Desires of	DIP-1			-	24.78	_	0000
⊎JC	θ _{JC} Thermal Resistance (Junction to Case)		SOIC-14	-	36.78	-	°C/W	

Notes:

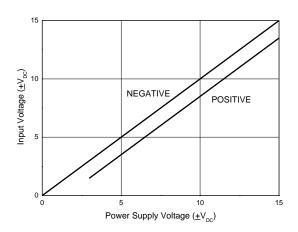
^{2.} Limits over the full temperature are guaranteed by design, but not tested in production.

^{3.} The input common-mode voltage of either input signal voltage should not be allowed to go negatively by more than 0.3V (at $+25^{\circ}$ C). The upper end of the common-mode voltage range is V_{CC} -1.5V (at $+25^{\circ}$ C), but either or both inputs can go to +36V without damages, independent of the magnitude of the V_{CC} .

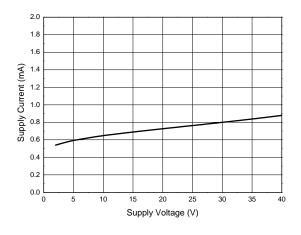


Performance Characteristics

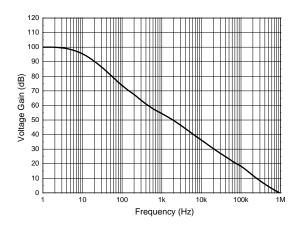
Input Voltage Range



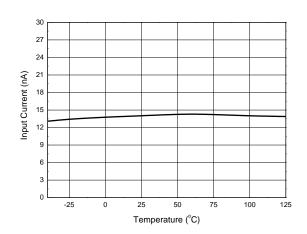
Supply Current



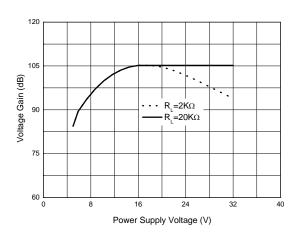
Open Loop Frequency Response



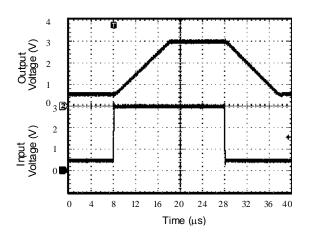
Input Current



Voltage Gain



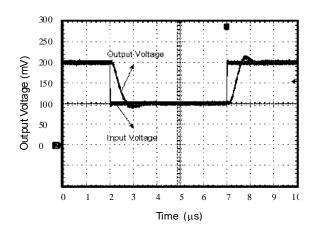
Voltage Follower Pulse Response



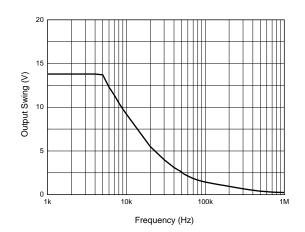


Performance Characteristics (Cont.)

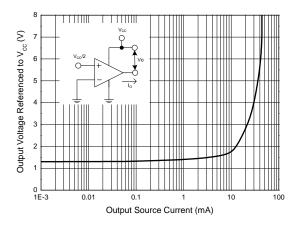
Voltage Follower Pulse Response (Small Signal)



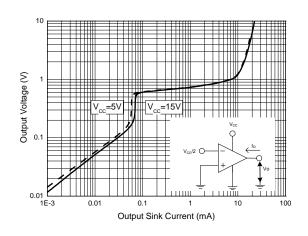
Large Signal Frequency Response



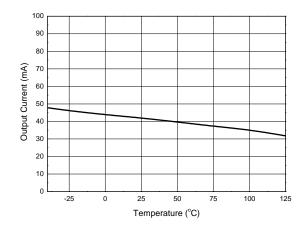
Output Characteristics: Current Sourcing



Output Characteristics: Current Sinking



Current Limiting

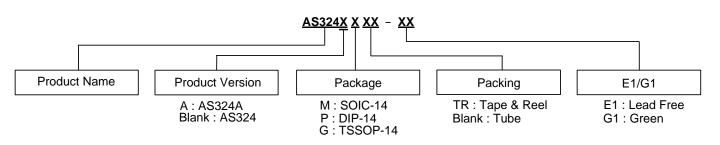






AS324/324A

Ordering Information



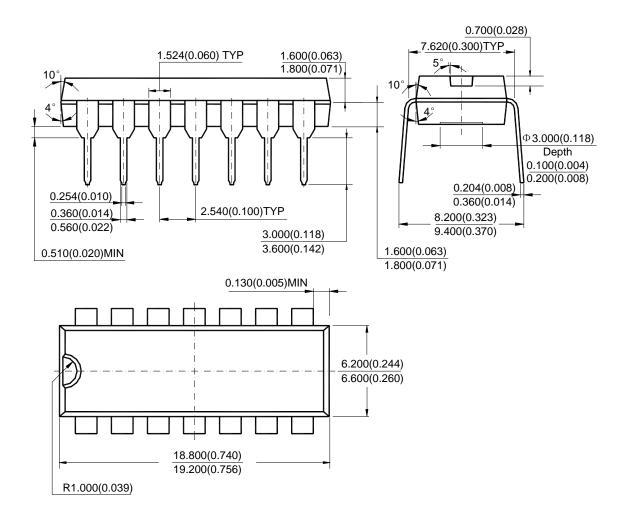
Diodes IC's Pb-free products, as designated with "E1" suffix in the part number, are RoHS compliant. Products with "G1" suffix are available in green packages.

Package	Temperature Range	Part Number		Marking ID		
		Lead Free	Green	Lead Free	Green	Packing Type
		AS324M-E1	AS324M-G1	AS324M-E1	AS324M-G1	Tube
SOIC-14	-40 to +85°C	AS324MTR-E1	AS324MTR-G1	AS324M-E1	AS324M-G1	Tape & Reel
		AS324AM-E1	AS324AM-G1	AS324AM-E1	AS324AM-G1	Tube
		AS324AMTR-E1	AS324AMTR-G1	AS324AM-E1	AS324AM-G1	Tape & Reel
DIP-14		AS324P-E1	AS324P-G1	AS324P-E1	AS324P-G1	Tube
TSSOP-14		AS324GTR-E1	AS324GTR-G1	EGS324	GGS324	Tape & Reel



Package Outline Dimensions (All dimensions in mm(inch).)

(1) Package Type: DIP-14

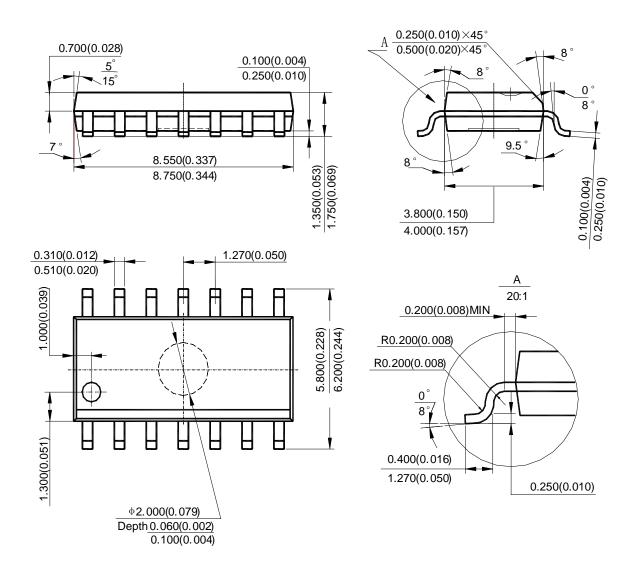


Note: Eject hole, oriented hole and mold mark is optional.



Package Outline Dimensions (Cont. All dimensions in mm(inch).)

(2) Package Type: SOIC-14

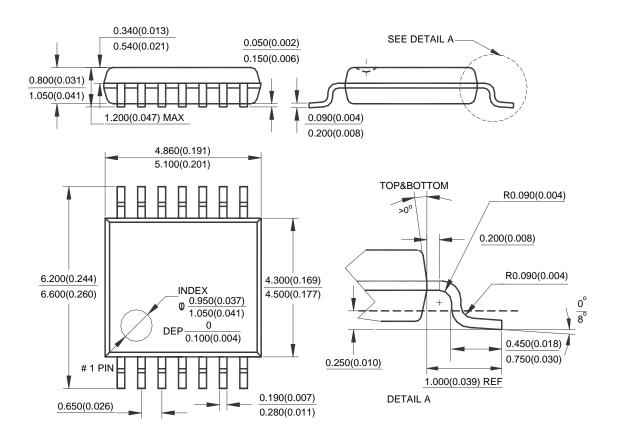


Note: Eject hole, oriented hole and mold mark is optional.



Package Outline Dimensions (Cont. All dimensions in mm(inch).)

(3) Package Type: TSSOP-14

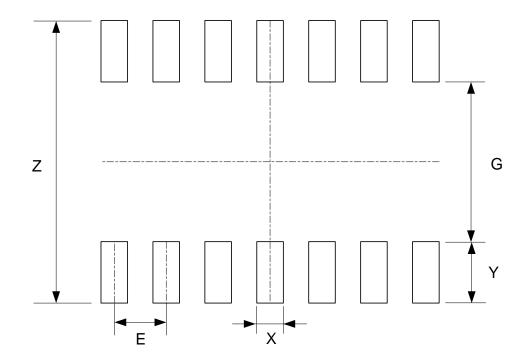


Note: Eject hole, oriented hole and mold mark is optional.



Suggested Pad Layout

(1) Package Type: SOIC-14

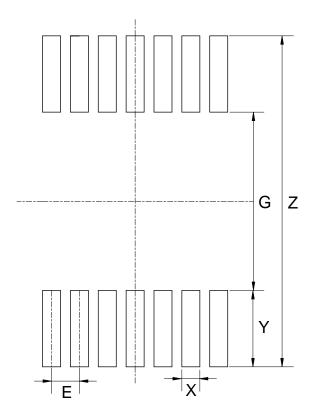


Dimensions	Z	G	X	Υ	E
Dimensions	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)
Value	6.900/0.272	3.900/0.154	0.650/0.026	1.500/0.059	1.270/0.050



Suggested Pad Layout (Cont.)

(2) Package Type: TSSOP-14



Dimensions	Z	G	X	Y	E
	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)
Value	7.720/0.304	4.160/0.164	0.420/0.017	1.780/0.070	0.650/0.026



AS324/324A

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